

## General Configuration

| Parameter                            | Value                     |
|--------------------------------------|---------------------------|
| Device Version                       | XA (conforms to AEC-Q200) |
| Package                              | 3.2 × 2.5 mm              |
| Output Frequency                     | 6.005284MHz               |
| Frequency Stability                  | ±50ppm                    |
| VDD Voltage                          | 3.3V                      |
| Output Type                          | HCMOS                     |
| Output Enable/Disable (E/D) Position | Pin 1                     |
| Temperature Grade                    | -40°C to +85°C            |

## Pin Assignments

| Number | Name    | Description  |
|--------|---------|--|
| 1      | OE      | Output Enable (0 = output disabled; pulled high internally). |
| 2      | GND     | Connect to ground.   |
| 3      | OUTPUT0 | Output.  |
| 4      | VDD     | Supply voltage.  |

## Revision History

| Revision Date    | Description of Change |
|------------------|-----------------------|
| December 5, 2018 | Initial release.      |

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